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ON Semiconductor NTHD5904NT1

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NTHD5904N

Power MOSFET

20 V, 4.5 A, Dual N-Channel, ChipFET™

Features

- Low R_{DS(on)} and Fast Switching Speed
- Leadless ChipFET Package has 40% Smaller Footprint than TSOP–6. Ideal Device for Applications Where Board Space is at a Premium.
- ChipFET Package Exhibits Excellent Thermal Capabilities. Ideal for Applications Where Heat Transfer is Required.
- Pb-Free Packages are Available

Applications

- DC-DC Buck or Boost Converters
- Low Side Switching
- Optimized for Battery and Low Side Switching Applications in Computing and Portable Equipment

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	20	V
Gate-to-Source Voltage			V_{GS}	±8.0	V
Continuous Drain	Steady	T _A =25°C	I _D	3.3	Α
Current (Note 1)	State	T _A =85°C		2.4	
	t ≤ 5 s	T _A =25°C		4.5	
Power Dissipation (Note 1)	Steady State	T _A =25°C	P_{D}	1.13	W
Continuous Drain	Steady	T _A =25°C	I _D	2.5	Α
Current (Note 2)		T _A =85°C		1.8	
Power Dissipation (Note 2)	State	T _A =25°C	P_{D}	0.64	W
Pulsed Drain Current	t _p =10	S	I _{DM}	10	Α
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to 150	°C
Source Current (Body Diode)			I _S	2.6	Α
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	110	°C/W
Junction–to–Ambient – $t \le 5$ s (Note 1)	$R_{\theta JA}$	60	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	195	

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

- Surface Mounted on FR4 Board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).
- Surface Mounted on FR4 Board using the minimum recommended pad size (Cu area = 0.214 in sq).
- 3. ESD Rating Information: Human Body Model (HBM) Class 0.

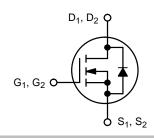


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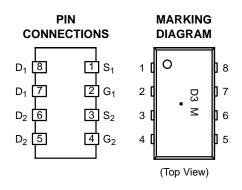
V _{(BR)DSS}	R _{DS(on)} TYP	I _D MAX	
20 V	40 mΩ @ 4.5 V	4.5 A	
	55 mΩ @ 2.5 V	4.071	

N-Channel MOSFET





ChipFET CASE 1206A STYLE 2



D3 = Specific Device Code M = Month Code

= Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

Datasheet of NTHD5904NT1 - MOSFET N-CH 20V 2.5A CHIPFET

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ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V	20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 16 V			1.0	μΑ
		V _{GS} = 0 V, V _{DS} = 16 V, T _J = 125°C			10	1
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8.0 \text{ V}$			±100	nA
ON CHARACTERISTICS (Note 4)						
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 250 \mu A$	0.6	0.75	1.2	V
Drain-to-Source On-Resistance	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 3.3 \text{ A}$		40	65	mΩ
		$V_{GS} = 2.5 \text{ V}, I_D = 2.3 \text{ A}$		55	105	1
Forward Transconductance	9FS	$V_{DS} = 10 \text{ V}, I_D = 3.3 \text{ A}$		6.0		S
CHARGES AND CAPACITANCES						
Input Capacitance	C _{iss}			465		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 16 V		65		1 !
Reverse Transfer Capacitance	C _{rss}	, no ,		30		1
Total Gate Charge	Q _{G(TOT)}			4.0		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 2.5 V, V _{DS} = 16 V,		0.4		
Gate-to-Source Charge	Q _{GS}	I _D = 3.3 A		0.8		
Gate-to-Drain Charge	Q_{GD}			2.0		
Total Gate Charge	Q _{G(TOT)}			6.0		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 10 V,		0.5		
Gate-to-Source Charge	Q _{GS}	I _D = 3.3 A		0.8		
Gate-to-Drain Charge	Q_{GD}			1.7		
SWITCHING CHARACTERISTICS (Note	5)					•
Turn-On Delay Time	t _{d(on)}			6.0		ns
Rise Time	t _r	V _{GS} = 4.5 V, V _{DS} = 16 V,		17		
Turn-Off Delay Time	t _{d(off)}	$I_D = 3.3 \text{ A}, R_G = 2.5 \Omega$		17		
Fall Time	t _f			5.1		
DRAIN-SOURCE DIODE CHARACTER	STICS					
Forward Diode Voltage	V_{SD}	$V_{GS} = 0 \text{ V}, I_{S} = 2.6 \text{ A}$		0.8	1.15	V
Reverse Recovery Time	t _{RR}			19.5		ns
Charge Time	ta	V _{GS} = 0 V, I _S = 2.6 A,		6.0		1
Discharge Time	t _b	$dI_{S}/dt = 100 \text{ A/}\mu\text{s}$		13		1
Reverse Recovery Charge	Q _{RR}	1		7.0		nC

^{4.} Pulse Test: Pulse Width $\leq 300 \,\mu\text{s}$, Duty Cycle $\leq 2\%$.

ORDERING INFORMATION

Device	Package	Shipping [†]
NTHD5904NT1	ChipFET	3000 / Tape & Reel
NTHD5904NT1G	ChipFET (Pb-Free)	3000 / Tape & Reel
NTHD5904NT3	ChipFET	10,000 / Tape & Reel
NTHD5904NT3G	ChipFET (Pb-Free)	10,000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{5.} Switching characteristics are independent of operating junction temperatures.

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TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

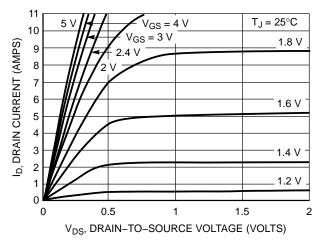


Figure 1. On-Region Characteristics

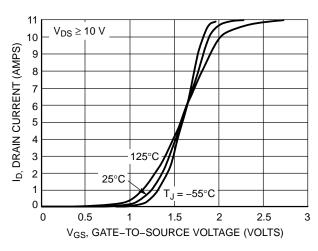


Figure 2. Transfer Characteristics

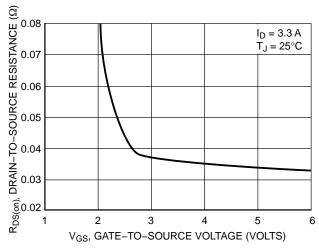


Figure 3. On-Resistance vs. Gate-to-Source Voltage

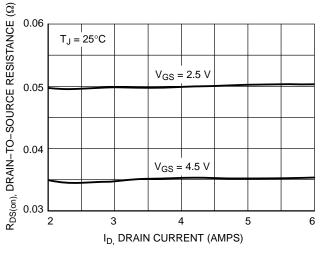


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

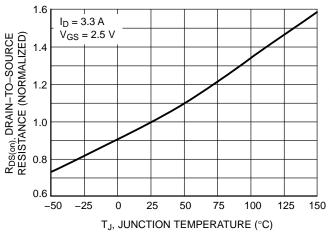


Figure 5. On–Resistance Variation with Temperature

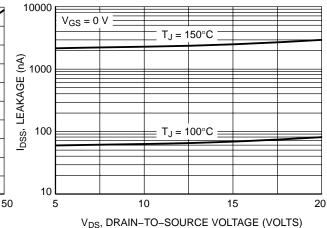


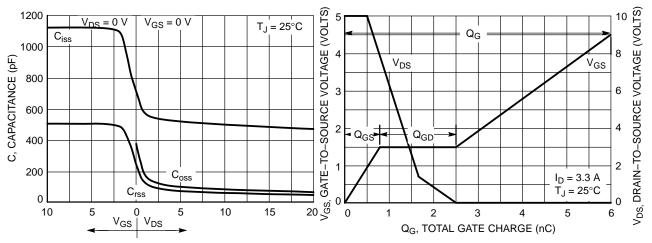
Figure 6. Drain-to-Source Leakage Current vs. Voltage

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TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



GATE-TO-SOURCE OR DRAIN-TO-SOURCE VOLTAGE (VOLTS)

Figure 7. Capacitance Variation

Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

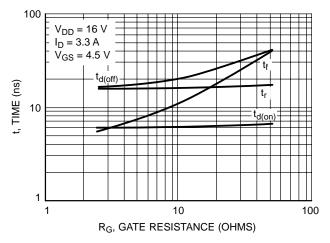


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

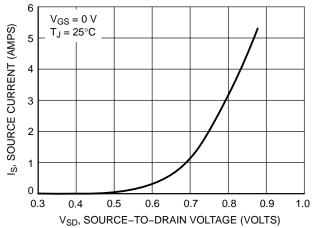


Figure 10. Diode Forward Voltage vs. Current

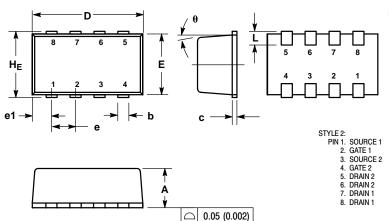
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PACKAGE DIMENSIONS

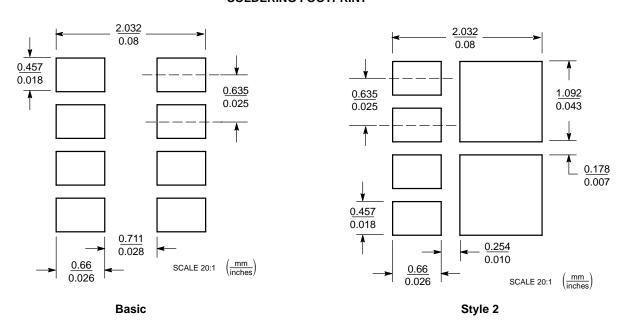
ChipFET™ CASE 1206A-03 ISSUE G



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. MOLD GATE BURRS SHALL NOT EXCEED 0.13 MM PER SIDE.
 4. LEADFRAME TO MOLDED BODY OFFSET IN HORIZONTAL
 AND VERTICAL SHALL NOT EXCEED 0.08 MM.
 5. DIMENSIONS A AND B EXCLUSIVE OF MOLD GATE BURRS.
 6. NO MOLD FLASH ALLOWED ON THE TOP AND BOTTOM LEAD SURFACE.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	1.00	1.05	1.10	0.039	0.041	0.043	
b	0.25	0.30	0.35	0.010	0.012	0.014	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
Е	1.55	1.65	1.70	0.061	0.065	0.067	
е	0.65 BSC				0.025 BSC		
e1	0.55 BSC				0.022 BSC		
L	0.28	0.35	0.42	0.011	0.014	0.017	
HE	1.80	1.90	2.00	0.071	0.075	0.079	
θ	5° NOM				5° NOM		

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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